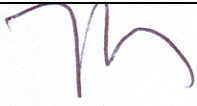






PRODUCT CHANGE NOTICE

DCS/PCN-1095

Contact Date:	Implementation Date:	Alert Category:	Alert Type:	PCN #:
Mar 11, 2008	June 9, 2008	Discrete Semiconductor	Alternate Die Sources	PCN #: 1095
TITLE				
Alternate Discrete Die Sources From CS & FA				
IMPACT				
None Identified.				
DESCRIPTION OF CHANGE				
<p>This PCN is to notify customers of qualification for additional source of specific dice in discrete devices currently being produced at our Factory in Shanghai, PRC. The new Wafer Fabs will provide additional capacity and improved delivery time for the products specified in the attachment. Full electrical characterization and high reliability testing including PV, ESD, HHT, HTRB, IOL, Autoclave, TC, and RSH will be completed using the alternate dice to ensure no change to device functionality or data sheet electrical specifications before production shipments.</p> <p>Samples of parts with the alternate dice are available upon request.</p>				
PRODUCTS AFFECTED				
See enclosed parts listing.				
WEB LINKS				
Manufacturer's Notice:	http://www.diodes.com/products/PCNs.shtml			
For More Information Contact:	http://www.diodes.com/contact/			
Data Sheet:	http://www.diodes.com/index.php			
				<input checked="" type="checkbox"/> ATTACHMENTS
DISCLAIMER				
<p>Unless a Diodes Inc. Sales representative is contacted in writing within 30 days of the posting of this notice, all changes described in this announcement are considered approved.</p>				
PCN APPROVAL				
Signatories	Name	Signature	Date	
Signature of Sr. Vice President, Sales & Mktg.	Mark King		March 11, 2008	
Signature of VP Corporate Administration	Ed Tang		March 4, 2008	
Signature of VP Product Development	Francis Tang		March 10, 2008	